2N3766 2N3767

SILICON NPN POWER TRANSISTORS



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DESCRIPTION:

The CENTRAL SEMICONDUCTOR 2N3766 and 2N3767 are silicon NPN power transistors manufactured by the epitaxial base process designed for power amplifier and medium speed switching applications.





| MAXIMUM F Collector-Ba | RATINGS: (T _C =25°C) se Voltage | SYMBOL V _{CBO} | 2N3766 80 | 2N3767 100 | UNITS V |
|--|---|-----------------------------------|---------------------|----------------------|------------|
| Collector-Em | nitter Voltage | V_{CEO} | 60 | 80 | V |
| Emitter-Base Voltage | | V_{EBO} | 6.0 | | V |
| Continuous Collector Current | | $I_{\mathbb{C}}$ | 4.0 | | Α |
| Continuous Base Current | | I_{B} | 2.0 | | Α |
| Power Dissipation | | P_{D} | 25 | | W |
| Operating and Storage Junction Temperature | | T _J , T _{stg} | -65 to +200 | | °C |
| Thermal Resistance | | ΘJC | 7.0 | | °C/W |
| ELECTRICA | L CHARACTERISTICS: (T _C =25°C ι | unless otherwise | noted) | | |
| SYMBOL | TEST CONDITIONS | MIN | M | ΑX | UNITS |
| I _{CBO} | V _{CB} =Rated V _{CBO} | | 1 | 0 | μΑ |
| I _{CEV} | V_{CE} =Rated V_{CEO} , V_{EB} =1.5 V | | 1 | 0 | μΑ |
| ICEO | V _{CF} =Rated V _{CFO} | | 50 | 00 | μA |

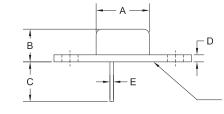
| | | | UNITS |
|---|---|---|--|
| V _{CB} =Rated V _{CBO} | | 10 | μA |
| V _{CE} =Rated V _{CEO} , V _{EB} =1.5V | | 10 | μΑ |
| V _{CE} =Rated V _{CEO} | | 500 | μΑ |
| V _{EB} =6.0V | | 500 | μΑ |
| I _C =100mA (2N3766) | 60 | | V |
| I _C =100mA (2N3767) | 80 | | V |
| I _C =500mA, I _B =50mA | | 1.0 | V |
| I _C =1.0A, I _B =100mA | | 2.5 | V |
| V_{CE} 10V, I_{C} =1.0A | | 1.5 | V |
| V_{CE} =5.0V, I_{C} =50mA | 30 | | |
| V_{CE} =5.0V, I_{C} =500mA | 40 | 160 | |
| V_{CE} =10V, I_{C} =1.0A | 20 | | |
| V_{CE} =10V, I_{C} =500mA, f=10MHz | 10 | | MHz |
| V_{CB} =10V, I_E =0, f=100kHz | | 50 | pF |
| | TEST CONDITIONS V _{CB} =Rated V _{CBO} V _{CE} =Rated V _{CEO} , V _{EB} =1.5V V _{CE} =Rated V _{CEO} V _{EB} =6.0V I _C =100mA (2N3766) I _C =100mA (2N3767) I _C =500mA, I _B =50mA I _C =1.0A, I _B =100mA V _{CE} =1.0A, I _C =50mA V _{CE} =5.0V, I _C =50mA V _{CE} =1.0V, I _C =500mA V _{CE} =10V, I _C =500mA, f=10MHz | TEST CONDITIONS V _{CB} =Rated V _{CBO} V _{CE} =Rated V _{CEO} , V _{EB} =1.5V V _{CE} =Rated V _{CEO} V _{EB} =6.0V I _C =100mA (2N3766) 60 I _C =100mA (2N3767) 80 I _C =500mA, I _B =50mA I _C =1.0A, I _B =100mA V _{CE} 10V, I _C =1.0A V _{CE} =5.0V, I _C =50mA 30 V _{CE} =5.0V, I _C =500mA 40 V _{CE} =10V, I _C =1.0A 20 V _{CE} =10V, I _C =500mA, f=10MHz 10 | VCB=Rated VCBO 10 VCE=Rated VCEO, VEB=1.5V 10 VCE=Rated VCEO 500 VEB=6.0V 500 IC=100mA (2N3766) 60 IC=100mA (2N3767) 80 IC=500mA, IB=50mA 1.0 IC=1.0A, IB=100mA 2.5 VCE10V, IC=1.0A 1.5 VCE=5.0V, IC=50mA 30 VCE=5.0V, IC=500mA 40 160 VCE=10V, IC=1.0A 20 VCE=10V, IC=500mA, f=10MHz 10 |

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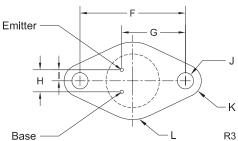
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TO-66 CASE - MECHANICAL OUTLINE



Seating Plane: The seating plane must be within 0.001" concave to 0.004" convex within 0.600" diameter from the center of the device.



MARKING: FULL PART NUMBER

| DIMENSIONS | | | | | | | | |
|------------|--------|-------|-------------|-------|--|--|--|--|
| | INCHES | | MILLIMETERS | | | | | |
| SYMBOL | MIN | MAX | MIN | MAX | | | | |
| A (DIA) | 0.470 | 0.500 | 11.94 | 12.70 | | | | |
| В | 0.250 | 0.340 | 6.35 | 8.64 | | | | |
| С | 0.360 | - | 9.14 | - | | | | |
| D | 0.050 | 0.075 | 1.27 | 1.91 | | | | |
| E (DIA) | 0.028 | 0.034 | 0.71 | 0.86 | | | | |
| F | 0.956 | 0.964 | 24.28 | 24.48 | | | | |
| G | 0.570 | 0.590 | 14.48 | 14.99 | | | | |
| Н | 0.190 | 0.210 | 4.83 | 5.33 | | | | |
| I | 0.093 | 0.107 | 2.36 | 2.72 | | | | |
| J (DIA) | 0.142 | 0.152 | 3.61 | 3.86 | | | | |
| K (RAD) | 0.141 | | 3.58 | | | | | |
| L (RAD) | 0.345 | | 8.76 | | | | | |

TO-66 (REV:R3)

OUTSTANDING SUPPORT AND SUPERIOR SERVICES



PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- · Inventory bonding
- · Consolidated shipping options

- · Custom bar coding for shipments
- · Custom product packing

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free quick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- · Custom electrical curves
- Environmental regulation compliance
- · Customer specific screening
- · Up-screening capabilities

- · Special wafer diffusions
- · PbSn plating options
- Package details
- · Application notes
- · Application and design sample kits
- · Custom product and package development

CONTACT US

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